2SD2051

Silicon NPN epitaxial planar type darlington

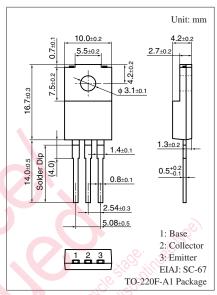
For low-frequency amplification

■ Features

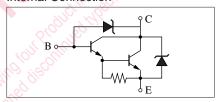
- High forward current transfer ratio h_{FE}
- Incorporating a built-in zener diode
- Full-pack package which can be installed to the heat sink with one screw.

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V _{CBO}	60±10	V	
Collector-emitter voltage (Base open)	V _{CEO}	60±10	V	
Emitter-base voltage (Collector open)	V_{EBO}	5	V	
Collector current	I_C	1.6	A	
Peak collector current	I_{CP}	2.5	A	
Collector power $T_C = 25^{\circ}C$	P _C	12	W	
dissipation		2.0		
Junction temperature	$T_{\rm j}$	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	



Internal Connection



■ Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

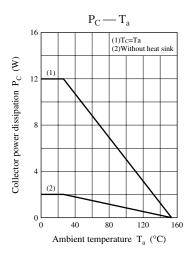
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_C = 100 \mu\text{A}, I_E = 0$	50		70	V
Collector-emitter voltage (Base open)	V _{CEO}	$I_C = 1 \text{ mA}, I_B = 0$	50		70	V
Emitter-base voltage (Collector open)	V _{EBO}	$I_E = 100 \mu\text{A}, I_C = 0$	5			V
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 25 \text{ V}, I_{E} = 0$			1	μΑ
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 4 \text{ V}, I_C = 0$			1	μΑ
Forward current transfer ratio *	h_{FE}	$V_{CE} = 10 \text{ V}, I_{C} = 1.0 \text{ A}$	4000		40 000	_
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 1.0 \text{ A}, I_B = 1.0 \text{ mA}$			1.5	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_C = 1.0 \text{ A}, I_B = 1.0 \text{ mA}$			2.2	V
Transition frequency	f_T	$V_{CE} = 10 \text{ V}, I_{C} = 10 \text{ mA}, f = 200 \text{ MHz}$		200		MHz

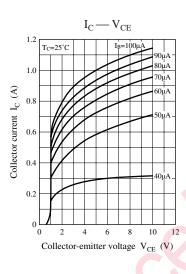
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

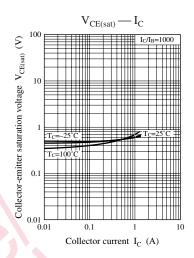
2. *: Rank classification

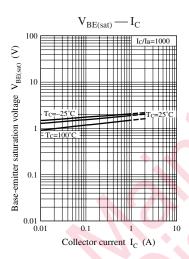
Rank	Q	R	S	
h_{FE}	4000 to 10000	8 000 to 20 000	1600 to 40000	

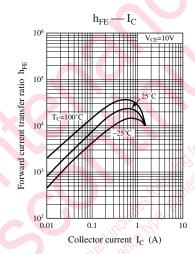
2SD2051 Panasonic

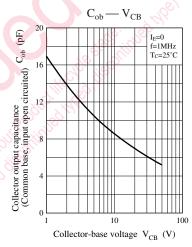












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